

## STGD3NC120H

## 7 A, 1200 V very fast IGBT

Datasheet - production data

#### **Features**

- High voltage capability
- High speed

#### **Applications**

- Home appliance
- Lighting

#### **Description**

This device is a very fast IGBT developed using advanced PowerMESH<sup>TM</sup> technology. This process guarantees an excellent trade-off between switching performance and low on-state behavior. This device is well-suited for resonant or soft-switching applications.

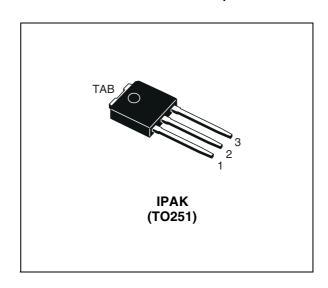


Figure 1. Internal schematic diagram

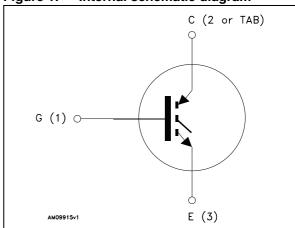


Table 1. Device summary

Order code	Marking	Package	Packaging
STGD3NC120H-1	GD3NC120H	IPAK (TO251)	Tube

Contents STGD3NC120H

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1	Electrical ratings
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STGD3NC120H Electrical ratings

## 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>CES</sub>	Collector-emitter voltage (V <sub>GE</sub> = 0)	1200	V
I <sub>C</sub> <sup>(1)</sup>	Continuous collector current at T <sub>C</sub> = 25 °C	16	Α
I <sub>C</sub> <sup>(1)</sup>	Continuous collector current at T <sub>C</sub> = 100 °C	9	Α
I <sub>CL</sub> <sup>(2)</sup>	Turn-off latching current	14	Α
I <sub>CP</sub> <sup>(3)</sup>	Pulsed collector current	20	Α
V <sub>GE</sub>	Gate-emitter voltage	± 20	V
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	105	W
TJ	Operating junction temperature	-55 to 150	°C

<sup>1.</sup> Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{j(max)} - T_{C}}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_{C}(T_{C}))}$$

- 2.  $V_{clamp}$  = 80%  $V_{CES}$ ,  $T_j$  = 150 °C,  $R_G$  = 10  $\Omega$ ,  $V_{GE}$  = 15 V
- 3. Pulse width limited by maximum junction temperature and turn-off within RBSOA

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thJC</sub>	Thermal resistance junction-case IGBT	1.2	°C/W
R <sub>thJA</sub>	R <sub>thJA</sub> Thermal resistance junction-ambient		°C/W

Electrical characteristics STGD3NC120H

## 2 Electrical characteristics

 $T_J = 25$  °C unless otherwise specified.

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)CES</sub>	Collector-emitter breakdown voltage (V <sub>GE</sub> = 0)	I <sub>C</sub> = 1 mA	1200			V
V <sub>CE(sat)</sub>	Collector-emitter saturation voltage	$V_{GE} = 15 \text{ V}, I_{C} = 3 \text{ A}$ $V_{GE} = 15 \text{ V}, I_{C} = 3 \text{ A}, T_{J} = 125 ^{\circ}\text{C}$		2.3 2.2	2.8	V V
V <sub>GE(th)</sub>	Gate threshold voltage	$V_{CE} = V_{GE}, I_{C} = 250 \mu A$	2		5	٧
I <sub>CES</sub>	Collector cut-off current (V <sub>GE</sub> = 0)	V <sub>CE</sub> = 1200 V V <sub>CE</sub> = 1200 V, T <sub>J</sub> =125 °C			50 1	μA mA
I <sub>GES</sub>	Gate-emitter leakage current (V <sub>CE</sub> = 0)	V <sub>GE</sub> = ± 20 V			± 100	nA
g <sub>fs</sub> <sup>(1)</sup>	Forward transconductance	V <sub>CE</sub> = 25 V <sub>,</sub> I <sub>C</sub> = 3 A		4		S

<sup>1.</sup> Pulse duration: 300 µs, duty cycle 1.5%

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>ies</sub> C <sub>oes</sub> C <sub>res</sub>	Input capacitance Output capacitance Reverse transfer capacitance	V <sub>CE</sub> = 25 V, f = 1 MHz, V <sub>GE</sub> =0	-	470 45 6	-	pF pF pF
Q <sub>g</sub> Q <sub>ge</sub> Q <sub>gc</sub>	Total gate charge Gate-emitter charge Gate-collector charge	V <sub>CE</sub> = 960 V, I <sub>C</sub> = 3 A,V <sub>GE</sub> =15 V	-	24 3 10	-	nC nC nC

Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub> t <sub>r</sub> (di/dt) <sub>on</sub>	Turn-on delay time Current rise time Turn-on current slope	$V_{CC}$ = 800 V, $I_{C}$ = 3 A $R_{G}$ = 10 $\Omega$ , $V_{GE}$ = 15 V, (see Figure 18)	-	15 3.5 880	-	ns ns A/µs
t <sub>d(on)</sub> t <sub>r</sub> (di/dt) <sub>on</sub>	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 800 \text{ V, } I_{C} = 3 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V,}$ $T_{J} = 125 ^{\circ}\text{C} \text{ (see Figure 18)}$	-	14.5 4 770	-	ns ns A/µs
$t_r(V_{off})$ $t_d(_{off})$ $t_f$	Off voltage rise time Turn-off delay time Current fall time	$V_{CC}$ = 800 V, $I_{C}$ = 3 A $R_{G}$ = 10 $\Omega$ , $V_{GE}$ = 15 V, (see Figure 18)	-	72 118 250	-	ns ns ns
$t_r(V_{off})$ $t_d(_{off})$ $t_f$	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 800 \text{ V}, I_{C} = 3 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V},$ $T_{J} = 125 ^{\circ}\text{C} \text{ (see Figure 18)}$	-	132 210 470	-	ns ns ns

Table 7. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Eon <sup>(1)</sup>	Turn-on switching losses	$V_{CC} = 800 \text{ V}, I_{C} = 3 \text{ A}$		236		μJ
E <sub>off</sub> (2)	Turn-off switching losses	$R_{G}$ = 10 $\Omega$ , $V_{GE}$ = 15 V,	-	290	-	μJ
E <sub>ts</sub>	Total switching losses	(see Figure 18)		526		μJ
Eon (1)	Turn-on switching losses	$V_{CC} = 800 \text{ V}, I_{C} = 3 \text{ A}$		360		μJ
E <sub>off</sub> (2)	Turn-off switching losses	$R_{G}$ = 10 $\Omega$ , $V_{GE}$ = 15 $V$ ,	-	620	-	μJ
E <sub>ts</sub>	Total switching losses	T <sub>J</sub> = 125 °C (see Figure 18)		980		μJ

Eon is the turn-on losses when a typical diode is used in the test circuit in figure 2. If the IGBT is offered in a package with a co-pack diode, the co-pack diode is used as external diode. IGBTs & Diode are at the same temperature (25 °C and 125 °C)

<sup>2.</sup> Turn-off losses include also the tail of the collector current

Electrical characteristics STGD3NC120H

#### 2.1 Electrical characteristics (curves)

Figure 2. Output characteristics

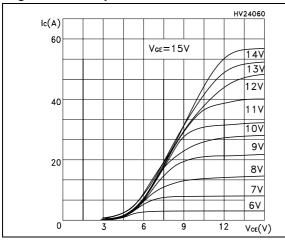


Figure 3. Transfer characteristics

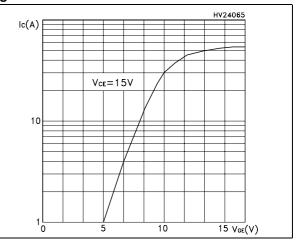
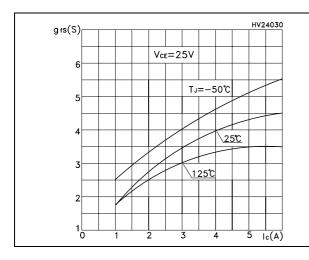


Figure 4. Transconductance

Figure 5. Collector-emitter on voltage vs. temperature



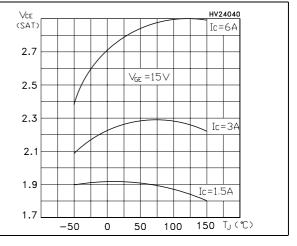
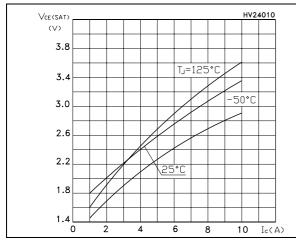
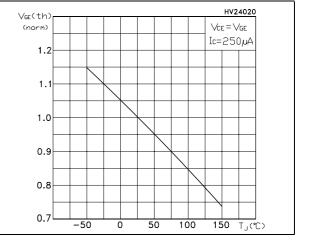


Figure 6. Collector-emitter on voltage vs. collector current

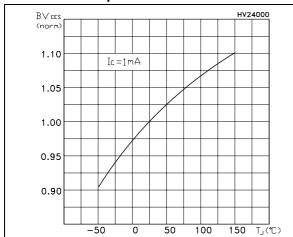
Figure 7. Normalized gate threshold voltage vs. temperature





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Figure 8. Normalized breakdown voltage vs. Figure 9. Gate charge vs. gate-source temperature voltage



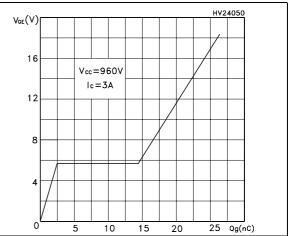


Figure 10. Capacitance variations

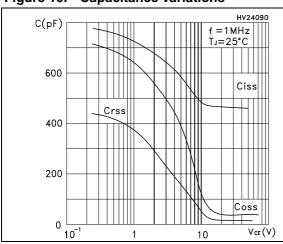


Figure 11. Switching losses vs. temperature

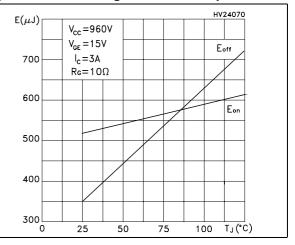


Figure 12. Switching losses vs. gate

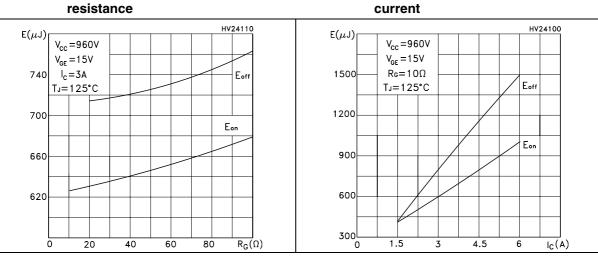


Figure 13. Switching losses vs. collector current

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Figure 14. Power losses @  $I_C = 3 A$ 

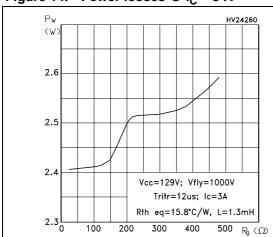


Figure 15. Power losses @ I<sub>C</sub> = 2 A

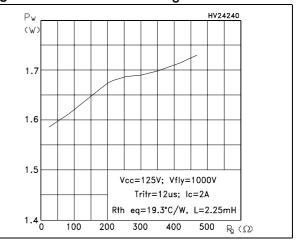


Figure 16. Turn-off SOA

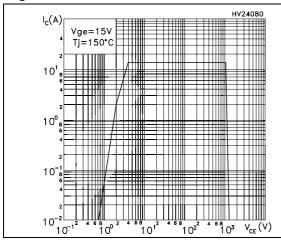
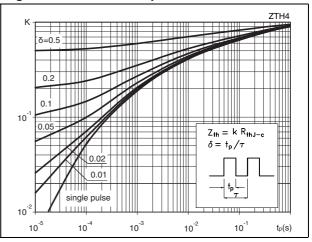


Figure 17. Thermal impedance



STGD3NC120H Test circuit

## 3 Test circuit

Figure 18. Test circuit for inductive load switching

Figure 19. Gate charge test circuit

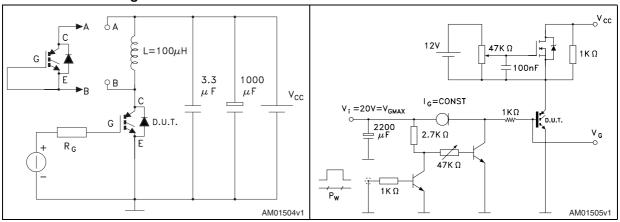
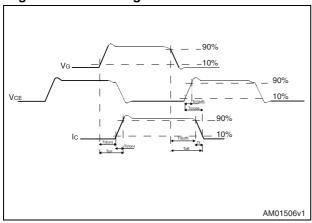


Figure 20. Switching waveform



## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

Table 8. IPAK (TO-251) mechanical data

4510 01		mm.	
DIM.	min.	typ	max.
Α	2.20		2.40
A1	0.90		1.10
b	0.64		0.90
b2			0.95
b4	5.20		5.40
B5		0.3	
С	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
E	6.40		6.60
е		2.28	
e1	4.40		4.60
Н		16.10	
L	9.00		9.40
L1	0.80		1.20
L2		0.80	1.00
V1		10 °	

Figure 21. IPAK (TO-251) drawing

Revision history STGD3NC120H

# 5 Revision history

Table 9. Document revision history

Date	Revision	Changes
27-Jun-2012	1	First release.

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